

PNP complex transistor with switching diode

			●Ou	ıtline			
Parameter	Value	•		DT-353 C-88A			2
V _{CEO}	-50\	/		(3) (2)	α)	60	
Ι _C	-150m	A		(4) (5)			
 Features The 2SA1774 and a control independently in a SOT Application Low-frequency Packaging specification 	-353 packag		~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~	UMT5 ner circuit (1) Di Anode (2) Tr Emitte (3) Tr Base (4) Tr Collec (5) Di Cathor	r tor	(15) Di (1) (2)	(4) Tr (3)
Part No. F	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
	SOT-353 (UMT5)	2021	TR	180	8	3000	L1

• Absolute maximum ratings ($T_a = 25^{\circ}C$)

Pin No.1-5 Diode

Parameter	Symbol	Value	Unit
Reverse voltage	V _R	80	V
Repetitive peak reverse voltage	V _{RM}	80	V
Average rectified current	١ _F	100	mA
Peak forward current	I _{FM}	300	mA
Surge current	I _{surge}	4	А
Rated in slash put frequency	f	100	MHz

Pin No.2-3-4 Transistor

Pin No.2-3-4 Transistor		9	
Parameter	Symbol	Value	Unit
Collector-base voltage	V _{CBO}	-60	V
Collector-emitter voltage	V _{CEO}	-50	V
Emitter-base voltage	V _{EBO}	-6	V
Collector current	Ic	-150	mA

Each element

Each element			
Parameter	Symbol	Value	Unit
Power dissipation	P _D *1,*2	150	mW/Total
Junction temperature	Tj	150	°C
Range of storage temperature	T _{stg}	-55 ~ +150	С°

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•Electrical characteristics (T_a = 25°C)

Pin No.1-5 Diode

Deremeter	Currence of	Conditions	Values			l locit	
Parameter	Symbol Conditions		Min.	Тур.	Max.	Unit	
Forward voltage	V_{F}	I _F = 100mA	-	-	1.2	V	
Reverse current	I _R	V _R = 70V	-		100	nA	
Capacitance between terminals	C _T	V _R = 6V , f = 1MHz	-		3.5	pF	
Reverse recovery time	t _{rr}	V _R = 6V , I _F = 5mA R _L = 50Ω (Figure 1)		-	4	ns	

Pin No.2-3-4 Transistor

Pin No.2-3-4 Transistor						
Parameter	Symbol	Conditions		Values	1	Unit
	- ,		Min.	Тур.	Max.	
Collector-base breakdown voltage	BV _{CBO}	I _C = -50μΑ	-60	-	-	V
Collector-emitter breakdown voltage	BV _{CEO}	Ic=-1mA	-50	-	-	V
Emitter-base breakdown voltage	BVEBO	Ι _Ε = -50μΑ	-6	-	-	V
Collector cut-off current	I _{CBO}	V _{CB} = -60V	-	-	-100	nA
Emitter cut-off current	I _{EBO}	V _{EB} = -5V	-	-	-100	nA
Collector-emitter saturation voltage	V _{CE(sat)}	I _C = -50mA, I _B = -5mA	-	-	-500	mV
DC current gain	h _{FE}	V _{CE} = -6V, I _C = -1mA	120	-	560	-
Transition frequency	f _T *3	V _{CE} = -12V, I _E = 2mA, f = 100MHz	-	140	-	MHz
Output capacitance	C _{ob}	V _{CB} = -12V, I _E = 0A, f = 1MHz	-	4.0	5.0	pF

*1 Each termunal mounted on a reference land.

*2 120mW per element must not be exceeded.

*3 Characteristics of built-in transistor.



•Electrical characteristic curves(T_a=25°C) <For Diode>

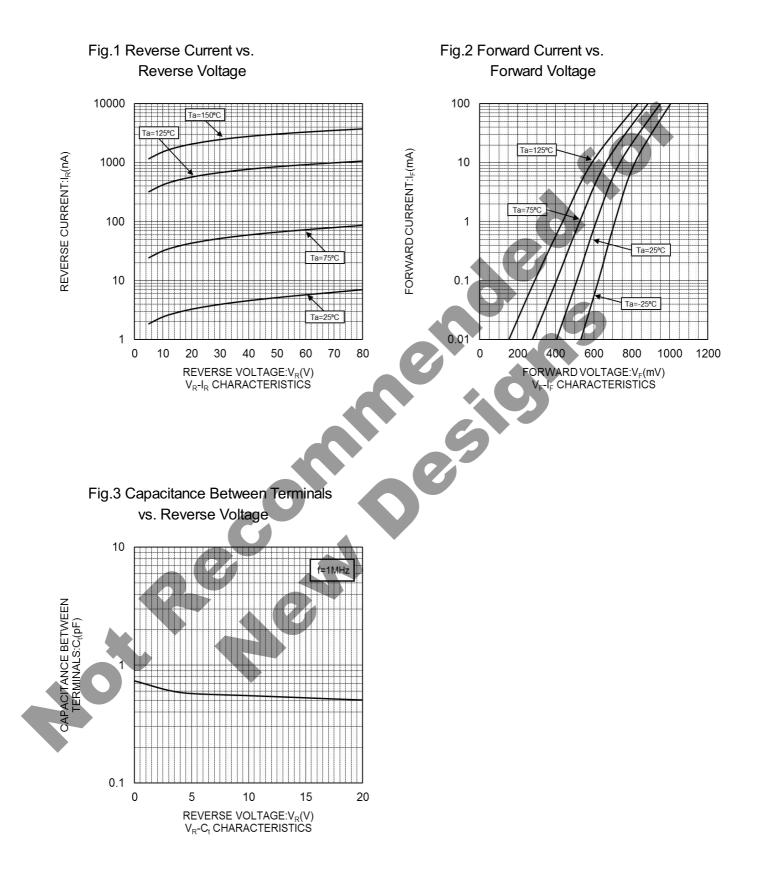
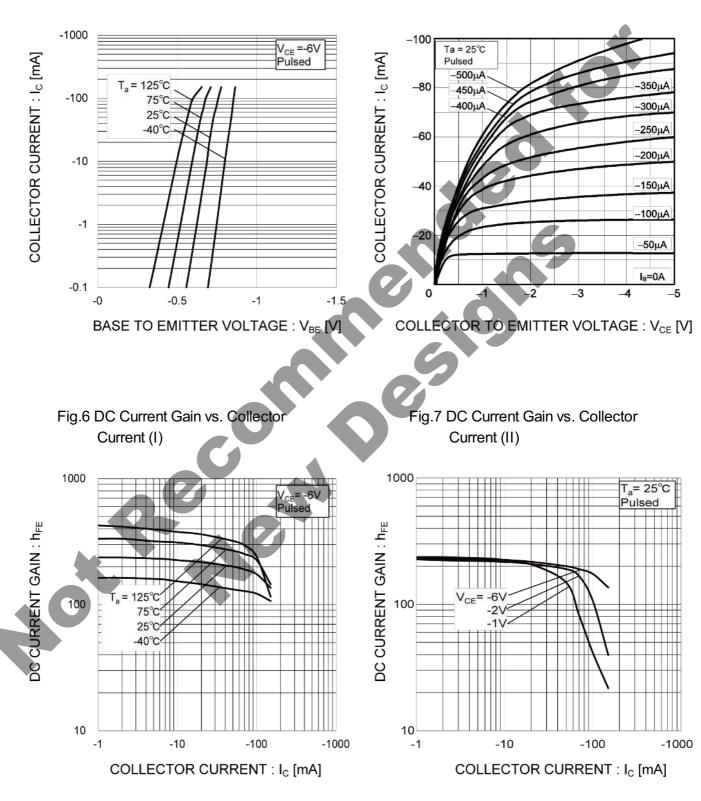




Fig.5 Typical Output Characteristics

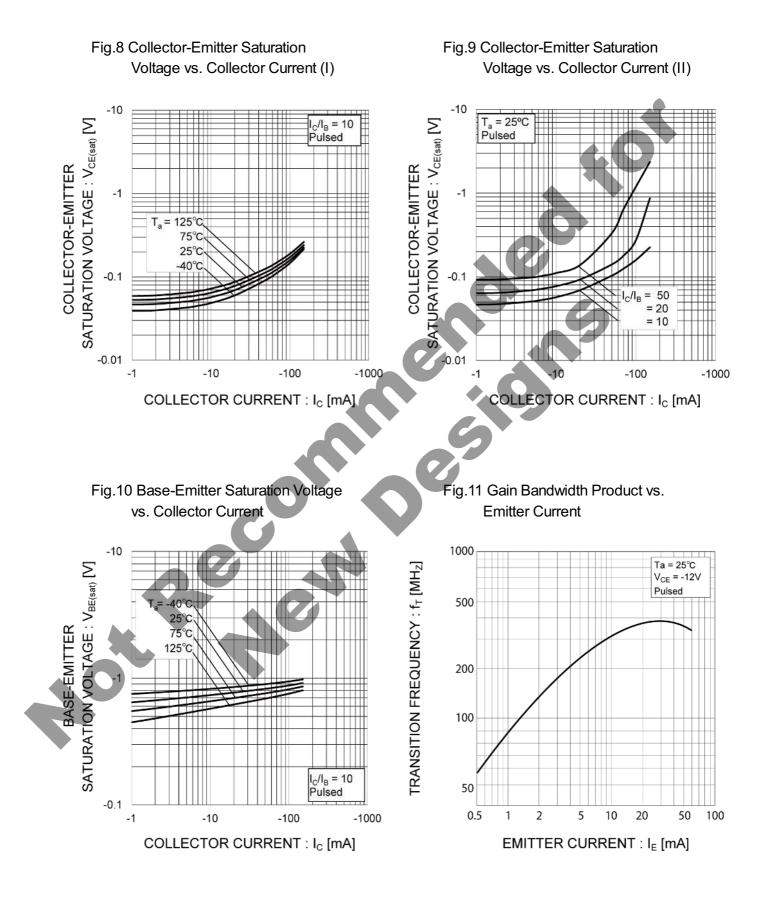
•Electrical characteristic curves(T_a=25°C) <For Transistor>







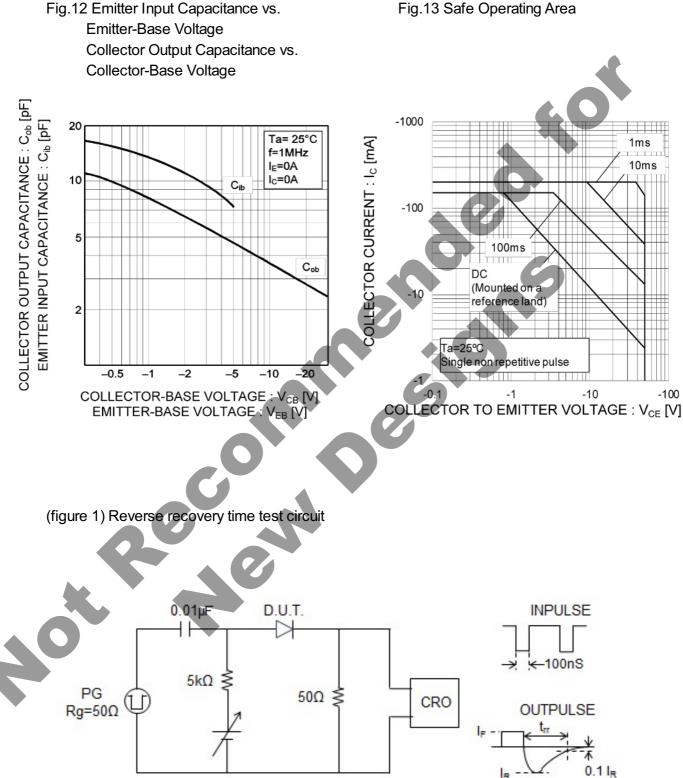
•Electrical characteristic curves(Ta=25°C) <For Transistor>





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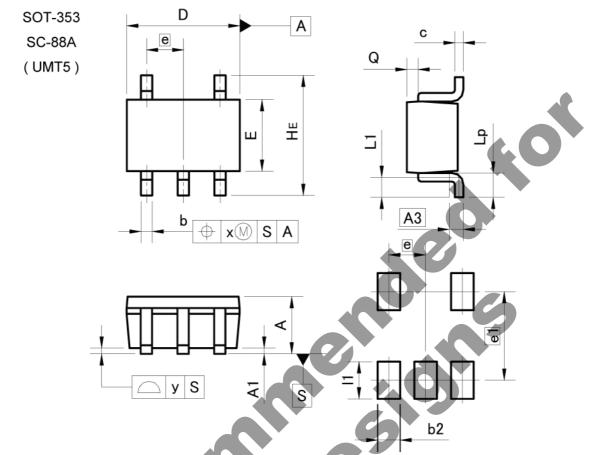
•Electrical characteristic curves(T_a=25°C) <For Transistor>





 I_R

Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES
	MIN	MAX	MIN	MAX
A	0.80	1.00	0.031	0.039
AI	0.00	0.10	0.000	0.004
A3	0.	25	0.0	10
b	0.15	0.30	0.006	0.012
С	0.10	0.20	0.004	0.008
D	1.90	2.10	0.075	0.083
E	1.15	1.35	0.045	0.053
е	0.0	35	0.0	26
HE	2.00	2.20	0.079	0.087
L1	0.10	0.40	0.004	0.016
Lp	0.25	0.55	0.010	0.022
Q	0.10	0.30	0.004	0.012
х	1	0.10	. 	0.004
У	3	0.10	. 	0.004

DIM	MILIM	MILIMETERS		HES
DIM	MIN	MAX	MIN	MAX
b2	530	0.40	055	0.016
e1	1.	1.55		061
11	 0	0.65		0.026

Dimension in mm/inches

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	(Note1) Medical E	Equipment Classifi	cation of the Spec	ific Applications
JAPAN		USA	FU	CHINA

JAPAN	USA	EU	CHINA
CLASSⅢ		CLASS II b	
CLASSⅣ	CLASSⅢ	CLASSⅢ	CLASSI

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 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.

De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.

- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
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 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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